

ID	R <sub>Ds</sub> (ON)(Typ)	VDSS	
10A	0.7Ω	650V	

#### Applications:

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

#### Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

# 

#### **Ordering Information**

Part Number	Package	Marking	Packing	Qty.
RS10N65F	T0-220F	RS10N65F	Tube	50 PCS

#### **Absolute Maximun Ratings Tc= 25**°C unless otherwise specified

Symbol	Parameter	R\$10N65F	Units
VDSS	Drain-to-Source Voltage	650	V
ID	Continuous Drain Current TC=25 $^{\circ}$ C	10	٨
IDM	Pulsed Drain Current (Note*1)	40	A
PD	Power Dissipation	39	W
VGS	Gate- to- Source Voltage	±30	V
EAS	Single Pulse Avalanche Engergy L = 10mH, VDD = 50V, RG = 25 Ω	320	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

\* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



#### **Thermal Resistance**

Symbol	Parameter	RS10N65F	Units	Test Conditions
RθJC	Junction-to-Case	1.92	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^\circ\!\!C$
RθJA	Junction-to- Ambient	62.5		1 cubic foot chamber,free air.

#### **OFF Characteristics** TJ= $25^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	650			V	VGS=0V,ID=250μ Α
IDSS	Drain- to- Source Leakage Current			1	μA	VDS=650V,VGS= 0V
	Gate- to- Source Forward Leakage			100	~ ^	VGS=30V ,VDS=0 V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS= 0V

## **ON Characteristics** TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		0.7	0.84	Ω	VGS=10V,ID=5A
VGS(TH )	Gate Threshold Voltage	3		4	V	VGS=VDS,ID=25 0μA

### **Resistive Switching Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		45			
trise	Rise Time		29			VDS=325V
td(OFF)	Turn- OFF Delay Time		201		nS	ID=10A RG=25Ω
tfall	Fall Time		69			



Symbol	Parameter	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Ciss	Input Capacitance		1377			VGS=0V
Coss	Output Capacitance		138		pF	VDS=25V
Crss	Reverse Transfer Capacitance		18			f=1.0MHz
Qg	Total Gate Charge		48			VDS=520V
Qgs	Gate- to- Source Charge		7		nC	ID=10A
Qgd	Gate-to-Drain(" Miller") Charge		23			VGS=10V

#### **Dynamic Characteristics** Essentially independent of operating temperature

#### **Source- Drain Diode Characteristics**

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			10	А	Integral pn- diode
ISM	Maximum Pulsed Current			40	А	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=5A,VGS=0V
trr	Reverse Recovery Time		524		nS	VGS=0V
Qrr	Reverse Recovery Charge		2.7		μC	IS=10A,di/dt=100 A/µs

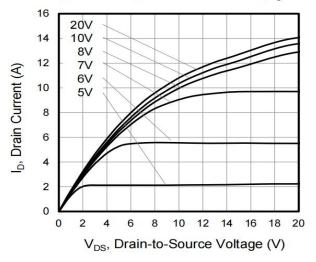
#### Notes:

- \* 1. Repetitive rating, pulse width limited by maximum junction temperature.
- \* 2. Pulse Test: Pulse width  $\leq$  300µs, Duty Cycle  $\leq$  1%

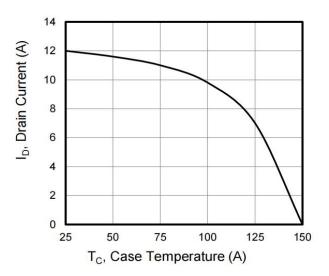


#### **Typical Feature Curve**

Figure 1. Output Characteristics (T<sub>J</sub> = 25°C)









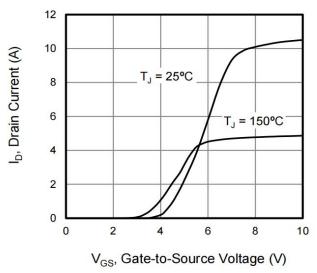


Figure 2. Body Diode Forward Voltage

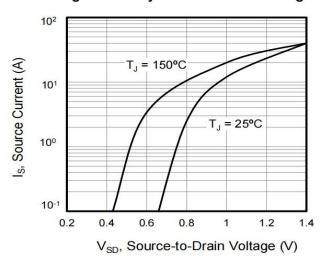


Figure 4. BV<sub>DSS</sub> Variation vs. Temperature

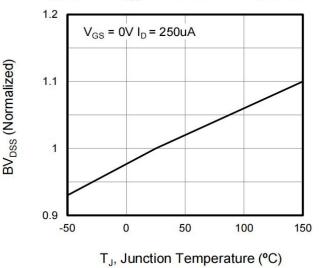
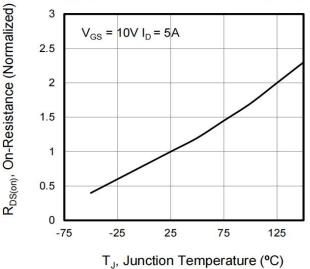


Figure 6. On-Resistance vs. Temperature





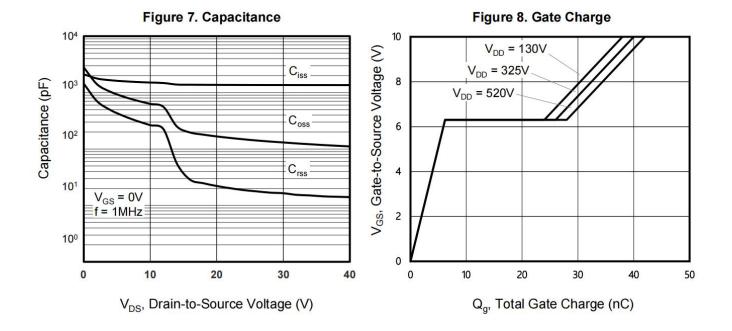


Figure 9. Transient Thermal Impedance

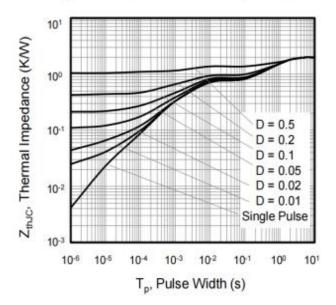
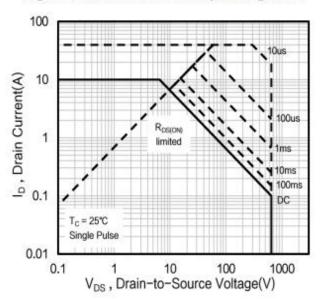


Figure 10. Maximum Safe Operating Area





#### **Test Circuits and Waveforms**



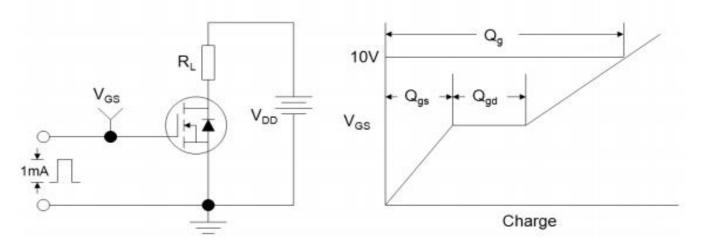
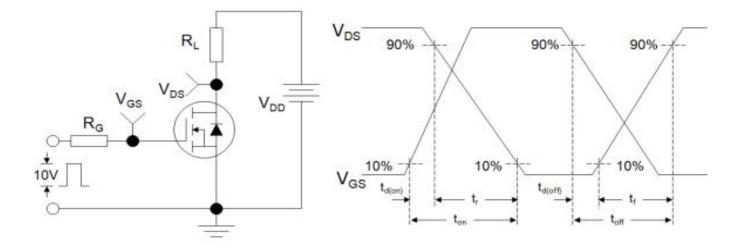
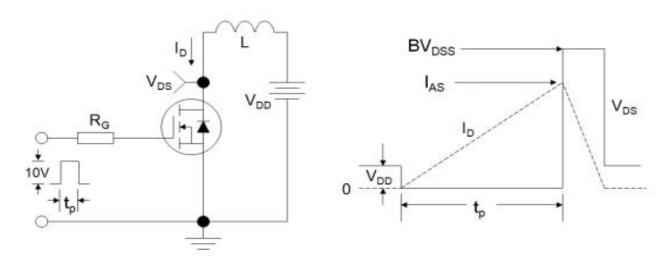


Figure B: Resistive Switching Test Circuit and Waveform

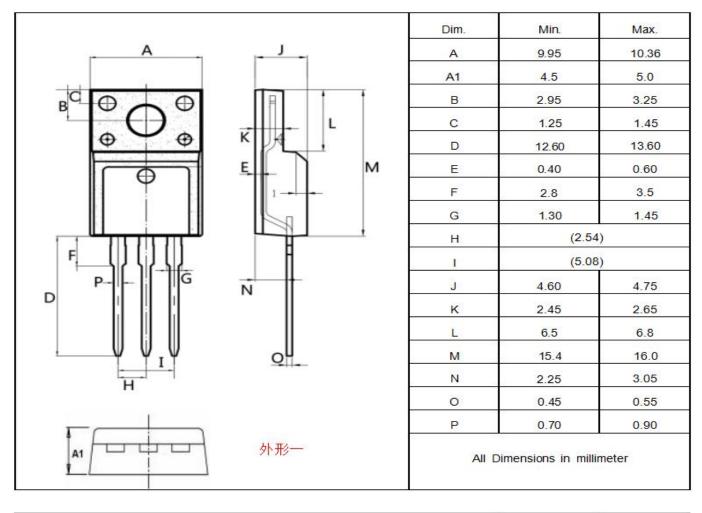


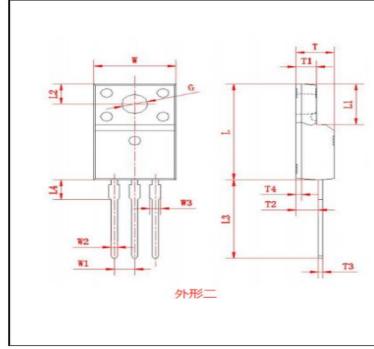






# Package outline drawing(TO-220F Unit: mm)





Dim.	Min.	Max.		
w	9.95	10.36		
W1	(2.54)			
W2	0.70	0.90		
W3	1.25	1.47		
L	15.67	16.07		
L1	6.48	6.88		
L2	3.2	3.4		
L3	12.6	13.6		
L4	(3.23	3)		
т	4.50	4.90		
T1	2.34	2.74		
Т2	2.25	2.95		
тз	0.45	0.60		
T4	(0.	70)		
G	3.08	3.28		



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